Si4835BDY

Vishay Siliconix



| SPECIFICATIONS (T _J = 25° C UNLESS OTHERWISE NOTED) | | | | | | |
|---|---------------------|---|------|-------|----------|------|
| Parameter | Symbol | Test Condition | Min | Тур | Мах | Unit |
| Static | | | | | | |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_D = -250 \ \mu A$ | -1.0 | | -3.0 | V |
| Gate-Body Leakage | I _{GSS} | V_{DS} = 0 V, V_{GS} = ±25 V | | | ±100 | nA |
| Zero Gate Voltage Drain Current | I _{DSS} | $V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55^{\circ}\text{C}$ | | | -1 -5 | μΑ |
| On-State Drain Current ^a | I _{D(on)} | V_{DS} \leq -5 V, V_{GS} = -10 V | -50 | | | Α |
| Drain-Source On-State Resistance ^a | r _{DS(on)} | $V_{GS} = -10 \text{ V}, \text{ I}_{D} = -9.6 \text{ A}$ | | 0.014 | 0.018 | Ω |
| | | $V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -7.5 \text{ A}$ | | 0.023 | 0.030 | |
| Forward Transconductancea | 9 _{fs} | $V_{DS} = -15 V$, $I_D = -9.6 A$ | | 30 | | S |
| Diode Forward Voltage ^a | V _{SD} | $I_{\rm S}$ = -2.1 A, $V_{\rm GS}$ = 0 V | | -0.8 | -1.2 | V |
| Dynamic ^b | | | | | | |
| Total Gate Charge | Qg | V_{DS} = -15 V, V_{GS} = -5 V, I_D = -9.6 A | | 25 | 37 | nC |
| Gate-Source Charge | Q _{gs} | | | 6.5 | | |
| Gate-Drain Charge | Q _{gd} | | | 12.5 | | |
| Gate Resistance | Rg | | 1.0 | 2.9 | 4.9 | Ω |
| Turn-On Delay Time | t _{d(on)} | $\label{eq:VDD} \begin{array}{l} V_{DD} = -15 \text{ V, } R_L = 15 \ \Omega \\ I_D \ \cong \ -1 \ A, \ V_{GEN} = -10 \ V, \ R_g = 6 \ \Omega \end{array}$ | | 15 | 25 | ns |
| Rise Time | t _r | | | 13 | 20 | |
| Turn-Off Delay Time | t _{d(off)} | | | 60 | 100 | |
| Fall Time | t _f | | | 45 | 70 | |
| Source-Drain Reverse Recovery Time | t _{rr} | I _F = -2.1 A, di/dt = 100 A/μs | | 45 | 80 | |

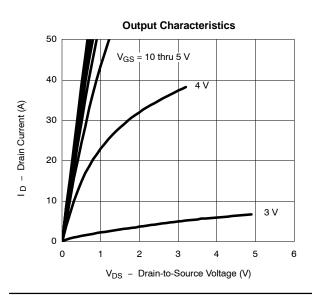
Notes

a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2%.

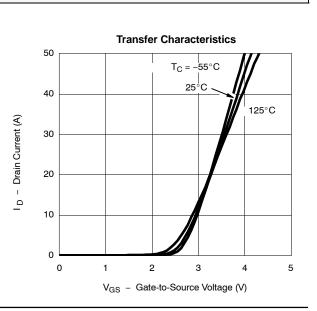
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)



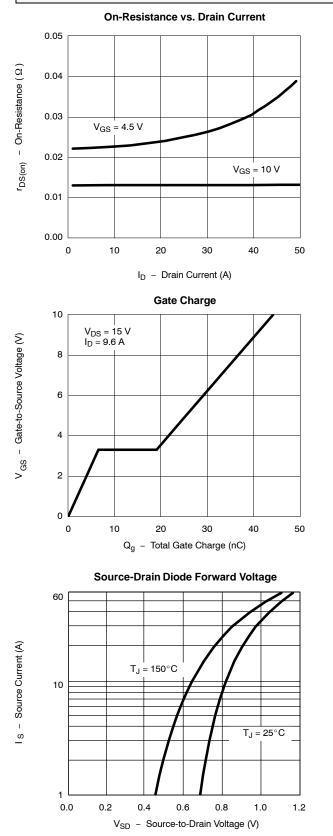
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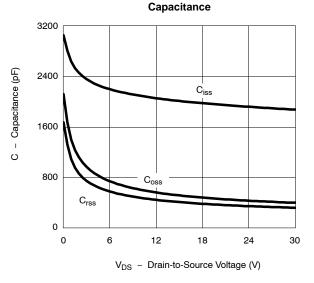




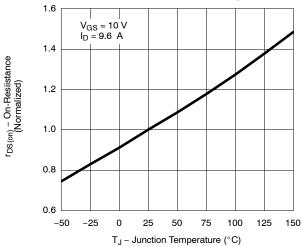
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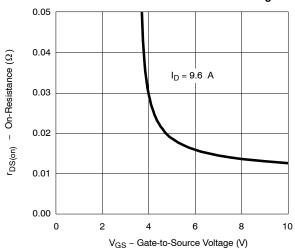




On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage



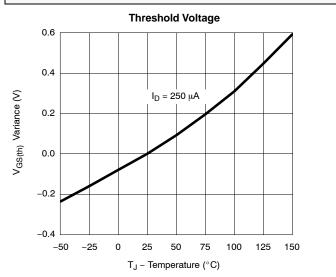
Document Number: 72029 S-41912—Rev. D, 25-Oct-04

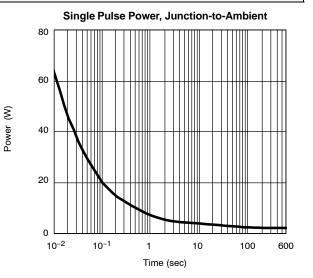
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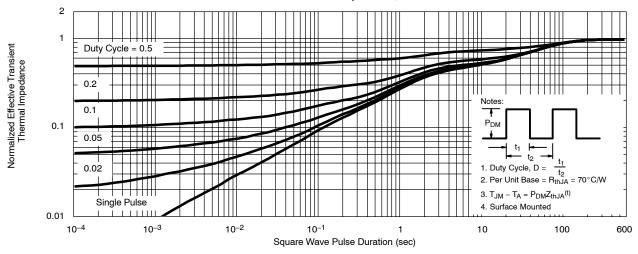
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Safe Operating Area 100 I_{DM} Limited 1 1 1 1 1 1 *r_{DS(on)} Limited P(t) = 0.000110 P(t) = 0.001 ID - Drain Current (A) +++++++P(t) = 0.01 I_{D(on)} 1 Limitéd P(t) = 0.1 P(t) = 1 T_A = 25°C 1.1.1 0.1 P(t) = 10 Single Pulse dc BV_{DSS} Limited 0.01 0.1 10 100 1 V_{DS} - Drain-to-Source Voltage (V) $*V_{GS}$ > minimum V_{GS} at which $r_{DS(on)}$ is specified

Normalized Thermal Transient Impedance, Junction-to-Ambient

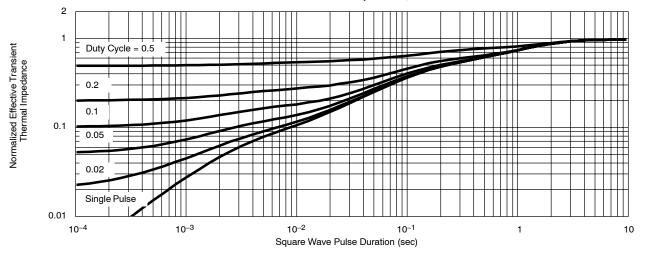


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TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?72029.



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